



Description

The DIODES™ 74LVC2G34 is a dual buffer gate with standard pushpull outputs. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down.

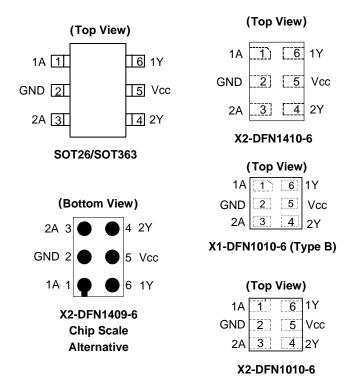
The gate performs the positive Boolean function:

Y = A

Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- ±24mA Output Drive at 3.0V
- CMOS Low Power Consumption
- I_{OFF} Supports Partial-Power-Down Mode Operation
- Inputs Accept up to 5.5V
- ESD Protection Tested per JESD 22
- Exceeds 2000V Human Body Model (A114)
- Exceeds 1000V Charged Device Model (C101)
- Latch-up Exceeds 100mA per JESD 78, Class I
- X2-DFN1409-6 Package Designed as a Direct Replacement for Chip Scale Packaging
- Range of Package Options SOT26, SOT363,
 X1-DFN1010-6 (Type B), X2-DFN1010-6, X2-DFN1409-6, and
 X2-DFN1410-6
- Leadless Packages Named per JESD30E
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Pin Assignments



Applications

- Voltage level shifting
- General purpose logics
- Power down signal isolations
- · Wide array of products such as:
 - PCs, networking, notebooks, netbooks, tablets
 - Computer peripherals, hard drives, SSD, CD/DVD ROM
 - TV, DVD, DVR, set-top boxes
 - Cell phones, personal navigations/GPS
 - MP3 players, cameras, video recorders

Notes:

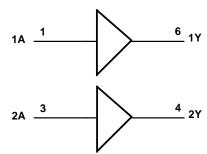
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Pin Descriptions

Pin Number	Pin Name	Function		
1	1A	Data Input		
2	GND	Ground		
3	2A	Data Input		
4	2Y	Data Output		
5	Vcc	Supply Voltage		
6	1Y	Data Output		

Logic Diagram



Function Table

Inputs	Output
Α	Y
Н	Н
L	L

Absolute Maximum Ratings (Notes 4 & 5) (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
Vcc	Supply Voltage Range	-0.5 to +6.5	V
Vı	Input Voltage Range	-0.5 to +6.5	V
Vo	Voltage Applied to Output in High Impedance or IOFF State	-0.5 to +6.5	V
Vo	Voltage Applied to Output in High or Low State	-0.3 to Vcc+0.5	V
lıĸ	Input Clamp Current V _I < 0	-50	mA
Іок	Output Clamp Current Vo < 0	-50	mA
lo	Continuous Output Current	-50	mA
_	Continuous Current through VDD or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C

Notes:

- 4. Stresses greater than those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.
- Exposure to Absolute Maximum Ratings for extended periods can affect device reliability.

 5. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.



Recommended Operating Conditions (Note 6) (@TA = +25°C, unless otherwise specified.)

Symbol		Parameter	Min	Max	Unit	
.,,	On a ratio a Malta sa	Operating	1.65	5.5	V	
Vcc	Operating Voltage	Data Retention Only	1.5	_	V	
		Vcc = 1.65V to 1.95V	0.65 x Vcc	_		
V	High Lovel Input Voltage	Vcc = 2.3V to 2.7V	1.7	_	V	
ViH	High-Level Input Voltage	$V_{CC} = 3V$ to $3.6V$	2	_	V	
		Vcc = 4.5V to 5.5V	0.7 x Vcc	_		
		V _{CC} = 1.65V to 1.95V	_	0.35 x V _{CC}		
\/	Low Lovel Input Voltage	VCC = 2.3V to $2.7V$	_	0.7	V	
VIL	Low-Level Input Voltage	$V_{CC} = 3V$ to $3.6V$	_	0.8	V	
		Vcc = 4.5V to 5.5V	_	0.3 x Vcc	1	
Vı	Input Voltage	•	0	5.5	V	
Vo	Output Voltage		0	Vcc	V	
		Vcc = 1.65V	_	-4		
	High-Level Output Current	Vcc = 2.3V	_	-8		
Іон			_	-16	mA	
		Vcc = 3V	_	-24		
		Vcc = 4.5V	_	-32		
		V _{CC} = 1.65V	_	4		
		Vcc = 2.3V	_	8		
loL	Low-Level Output Current	\/ 2\/	_	16	mA	
		Vcc = 3V	_	24		
		$V_{CC} = 4.5V$	_	32	1	
		$V_{CC} = 1.8V \pm 0.15V, 2.5V \pm 0.2V$	_	20		
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 3.3V \pm 0.3V$	_	10	ns/V	
		$V_{CC} = 5V \pm 0.5V$	_	5		
TA	Operating Free-Air Temperature	_	-40	+125	°C	

Note:

6. Unused inputs should be held at $\ensuremath{V_{\text{CC}}}$ or Ground.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Cumbal	Devemeter	Test Conditions	V	+40°C to	o +85°C	-40°C to	+125°C	Unit	
Symbol	Parameter	rest Conditions	Vcc	Min	Max	Min	Max	Onit	
		Іон = -100μΑ	1.65V to 5.5V	Vcc - 0.1		Vcc - 0.1	_		
		IOH = -4mA	1.65V	1.2		0.95	1		
Voн	High-Level Output	$I_{OH} = -8mA$	2.3V	1.9	_	1.7	_	V	
VOH	Voltage	Iон = -16mA	- 3V	2.4	-	2.2	_	V	
		Iон = -24mA	34	2.3	_	2.0	_		
		Iон = -32mA	4.5V	3.8	_	3.4	_		
		I _{OL} = 100μA	1.65V to 5.5V	_	0.1	_	0.1		
		IoL = 4mA	1.65V	_	0.45	_	0.70		
Va	Low-Level Output	IoL = 8mA	2.3V	_	0.3	_	0.45	V	
Vol	Voltage	I _{OL} = 16mA	3V	_	0.4	_	0.60	V	
		$I_{OL} = 24mA$	34	_	0.55	_	0.80		
		IoL = 32mA	4.5V	_	0.55	_	0.80		
lı	Input Current	V _I = 5.5V or GND	0 to 5.5V	_	±5	_	±20	μΑ	
loff	Power Down Leakage Current	V _I or V _O = 5.5V	0	_	±10	_	±20	μΑ	
Icc	Supply Current	$V_1 = 5.5V$ or GND, $I_0 = 0$	1.65V to 5.5V	_	10		40	μΑ	
Δlcc	Additional Supply Current	Input at Vcc – 0.6V	3V to 5.5V	_	500	_	5000	μΑ	



Package Characteristics ($@T_A = +25^{\circ}C$, $V_{CC} = 3.3V$, unless otherwise specified.)

Symbol	Parameter	Package	Conditions	Min	Тур	Max	Unit
Сі	Input Capacitance	Typical of All Packages	$V_{CC} = 3.3V$ $V_{I} = V_{CC}$ or GND	_	3.5	_	pF
		SOT26		_	204	_	
		SOT363		_	371	_	
0	Thermal Resistance Junction-	X2-DFN1410-6	(Note 7)	_	430	_	°C/W
θја	to-Ambient	X2-DFN1409-6	(Note 7)	_	450	_	C/VV
		X1-DFN1010-6 (Type B)	1	_	495	_	
		X2-DFN1010-6		_	510	_	
		SOT26		_	52	_	
		SOT363	1	_	143	_	
0	Thermal Resistance Junction-	X2-DFN1410-6	(NI=4= 7)	_	190	_	°C/W
θЈС	to-Case	X2-DFN1409-6	(Note 7)	_	225	_	
		X1-DFN1010-6 (Type B)	1	_	245	_	
		X2-DFN1010-6	1	_	250	_	

Note:

Switching Characteristics

 $T_A = -40$ °C to +85°C, $C_L = 30$ or 50pF (See Figure 1)

Parameter	From	To (Output)		= 1.8V 15V		= 2.5V .2V	Vcc = ±0	: 3.3V .3V	Vcc ±0	= 5V .5V	Unit
	(Input)	(Output)	Min	Max	Min	Max	Min	Max	Min	Max	
tpD	Α	Y	0.5	8.6	0.5	4.4	0.5	4.1	0.5	3.2	ns

 $T_A = -40$ °C to +125°C, $C_L = 30$ or 50pF (See Figure 1)

Parameter	From	To (Output)		= 1.8V 15V		= 2.5V).2V	Vcc = ±0	: 3.3V .3V	Vcc ±0	= 5V .5V	Unit
	(Input)) (Output)	Min	Max	Min	Max	Min	Max	Min	Max	
tpD	Α	Y	0.5	10.8	0.5	5.5	0.5	5.1	0.5	4.0	ns

Operating Characteristics

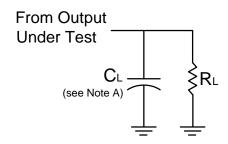
$T_A = +25$ °C

	Parameter	Test Conditions	Vcc = 1.8V Typ	Vcc = 2.5V Typ	Vcc = 3.3V Typ	Vcc = 5V Typ	Unit
C _{PD}	Power Dissipation Capacitance	f = 10MHz	17	19	20	21	pF

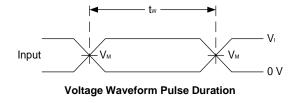
^{7.} Test condition for all packages: Device mounted on FR-4 substrate PC board, 2oz copper with minimum recommended pad layout.

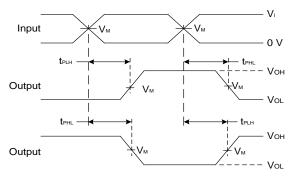


Parameter Measurement Information



Vcc	Inp	outs	VM	C.	RL	
VCC	Vı	t _r /t _f	V M	C∟	NL NL	
1.8V ± 0.15V	Vcc	≤ 2ns	Vcc/2	30pF	1kΩ	
2.5V ± 0.2V	Vcc	≤ 2ns	V _{CC} /2	30pF	500Ω	
$3.3V \pm 0.3V$	3V	≤ 2.5ns	1.5V	50pF	500Ω	
5V ± 0.5V	Vcc	≤ 2.5ns	Vcc/2	50pF	500Ω	





Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1. Load Circuit and Voltage Waveforms

Notes: A. Includes test lead and test apparatus capacitance.

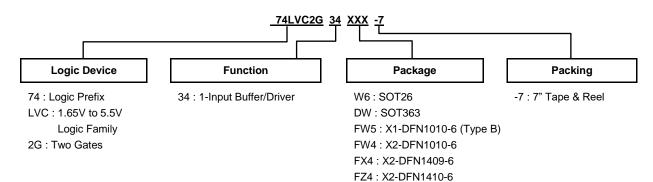
B. All pulses are supplied at pulse repetition rate \leq 10MHz.

C. Inputs are measured separately one transition per measurement.

D. t_{PLH} and t_{PHL} are the same as t_{PD} .



Ordering Information



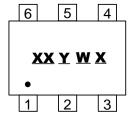
Part Number	Part Number	Package	Package (Note 8)	Package Size	Packing	Packing (Note 9)		
Part Number	Suffix	Code	Fackage (Note 6)	Fackage Size	Qty.	Carrier		
74LVC2G34W6-7	-7	W6	SOT26	2.8mm x 2.2mm x 1.1mm 0.95mm Lead Pitch	3000	Tape & Reel		
74LVC2G34DW-7	-7	DW	SOT363	2.0mm x 2.0mm x 1.1mm 0.65mm Lead Pitch	3000	Tape & Reel		
74LVC2G34FW5-7	-7	FW5	X1-DFN1010-6 (Type B)	1.0mm x 1.0mm x 0.5mm 0.35mm Pad Pitch	5000	Tape & Reel		
74LVC2G34FW4-7	-7	FW4	X2-DFN1010-6	1.0mm x 1.0mm x 0.4mm 0.35mm Pad Pitch	5000	Tape & Reel		
74LVC2G34FX4-7	-7	FX4	X2-DFN1409-6 Chip Scale Alternative	1.4mm x 0.9mm x 0.4mm 0.5mm Pad Pitch	5000	Tape & Reel		
74LVC2G34FZ4-7	-7	FZ4	X2-DFN1410-6	1.4mm x 1.0mm x 0.4mm 0.5mm Pad Pitch	5000	Tape & Reel		

Notes: 8. Pad layout as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html. 9. The taping orientation is located on our website https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf.

Marking Information

(1) SOT26, SOT363

(Top View)



XX: Identification Code
Y: Year 0 to 9 (ex: 2 = 2022)
W: Week: A to Z: Week 1 to 26;
a to z: Week 27 to 52; z Represents

Week 52 and 53 X: A to Z: Internal Code

Part Number	Package	Identification Code
74LVC2G34W6-7	SOT26	Z 7
74LVC2G34DW-7	SOT363	Z7



Marking Information (continued)

(2) X1-DFN1010-6 (Type B), X2-DFN1010-6, X2-DFN1409-6, X2-DFN1410-6

(Top View)



 \underline{XX} : Identification Code \underline{Y} : Year 0 to 9 (ex: 2 = 2022) \underline{W} : Week: A to Z: Week 1 to 26;

a to z: Week 27 to 52; z Represents

Week 52 and 53 X: A to Z: Internal Code

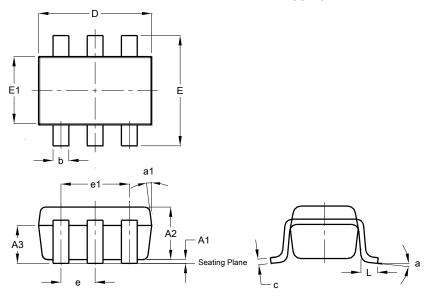
Part Number	Package	Identification Code
74LVC2G34FW4-7	X2-DFN1010-6	Z7
74LVC2G34FW5-7	X1-DFN1010-6 (Type B)	W7
74LVC2G34FX4-7	X2-DFN1409-6	X7
74LVC2G34FZ4-7	X2-DFN1410-6	Z7



Package Outline Dimensions

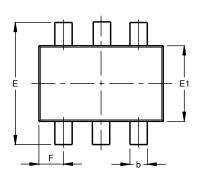
Please see http://www.diodes.com/package-outlines.html for the latest version.

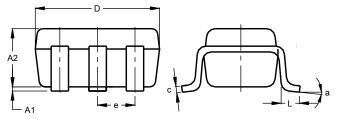
SOT26



	SOT26			
Dim	Min	Max	Тур	
A1	0.013	0.10	0.05	
A2	1.00	1.30	1.10	
А3	0.70	0.80	0.75	
b	0.35	0.50	0.38	
С	0.10	0.20	0.15	
D	2.90	3.10	3.00	
е		-	0.95	
e1	-	-	1.90	
Е	2.70	3.00	2.80	
E1	1.50	1.70	1.60	
L	0.35	0.55	0.40	
а	-	-	8°	
a1	-	-	7°	
All Dimensions in mm				

SOT363





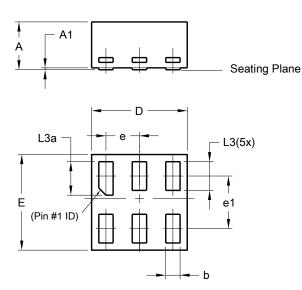
SOT363			
Dim	Min	Max	Тур
A1	0.00	0.10	0.05
A2	0.90	1.00	0.95
b	0.10	0.30	0.25
С	0.10	0.22	0.11
D	1.80	2.20	2.15
Е	2.00	2.20	2.10
E1	1.15	1.35	1.30
е	e 0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
а	0°	8°	
All Dimensions in mm			



Package Outline Dimensions (continued)

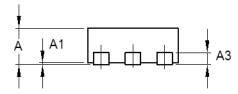
Please see http://www.diodes.com/package-outlines.html for the latest version.

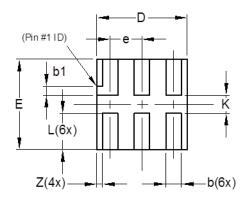
X1-DFN1010-6 (Type B)



	X1-DFN1010-6			
Dim	(Type B) Dim Min Max Typ			
Α	-	0.50	0.39	
A1	-	0.04	-	
b	0.12	0.20	0.15	
D	0.95	1.050	1.00	
Е	0.95	1.050	1.00	
е	e 0.35 BSC			
e1	0.55 BSC			
L3	0.27	0.30	0.30	
L3a	0.32	0.40	0.35	
All Dimensions in mm				

X2-DFN1010-6





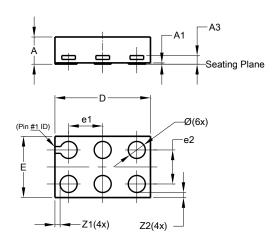
X2-DFN1010-6			
Dim	Min	Max	Тур
Α	_	0.40	0.39
A1	0.00	0.05	0.02
A3	_	_	0.13
b	0.14	0.20	0.17
b1	0.05	0.15	0.10
D	0.95	1.05	1.00
Е	0.95	1.05	1.00
е	_	_	0.35
L	0.35	0.45	0.40
K	0.15	_	_
Z	_		0.065
All Dimensions in mm			



Package Outline Dimensions (continued)

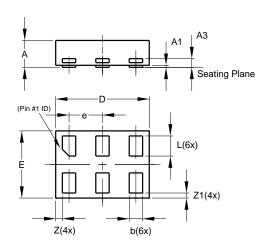
Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1409-6



	X2-DFN1409-6				
Dim	Dim Min Max Typ				
Α	-	0.40	0.39		
A1	0	0.05	0.02		
A3	-	-	0.13		
Ø	0.20	0.30	0.25		
D	1.35	1.45	1.40		
Е	0.85	0.95	0.90		
e1	-	-	0.50		
e2	-	-	0.50		
Z 1	-	-	0.075		
Z2	-	-	0.075		
All Dimensions in mm					

X2-DFN1410-6



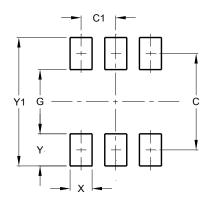
X2-DFN1410-6			
Dim	Min	Max	Тур
Α		0.40	0.39
A1	0.00	0.05	0.02
A3			0.13
b	0.15	0.25	0.20
D	1.35	1.45	1.40
Е	0.95	1.05	1.00
е			0.50
L	0.25	0.35	0.30
Z			0.10
Z1	0.045	0.105	0.075
All Dimensions in mm			



Suggested Pad Layout

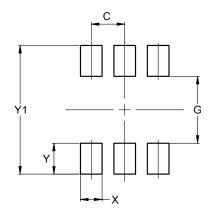
Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT26



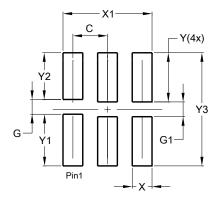
Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20

SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500

X1-DFN1010-6 (Type B)



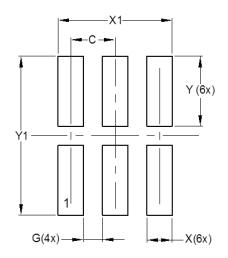
Dimensions	Value (in mm)
С	0.350
G	0.150
G1	0.150
Х	0.200
X1	0.900
Υ	0.500
Y1	0.525
Y2	0.475
Y3	1.150



Suggested Pad Layout (continued)

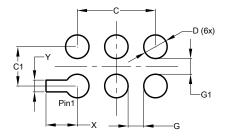
Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1010-6



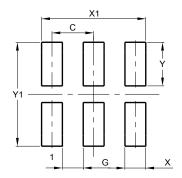
Dimensions	Value (in mm)
С	0.350
G	0.150
Х	0.200
X1	0.900
Y	0.550
Y1	1.250

X2-DFN1409-6



Dimensions	Value (in mm)
С	1.000
C1	0.500
D	0.300
G	0.200
G1	0.200
Х	0.400
Υ	0.150

X2-DFN1410-6



Dimensions	Value (in mm)
С	0.500
G	0.250
Х	0.250
X1	1.250
Υ	0.525
Y1	1.250



Mechanical Data

SOT26

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.016 grams (Approximate)

SOT363

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.006 grams (Approximate)

X1-DFN1010-6 (Type B)

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.001 grams (Approximate)

X2-DFN1010-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.001 grams (Approximate)

X2-DFN1409-6

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.002 grams (Approximate)

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